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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
10/709,664	05/21/2004	Min-Hsun Hsieh	KYCP0009USA1	3663		
27765 7	590 07/26/2005		EXAMINER			
NORTH AMERICA INTERNATIONAL PATENT OFFICE (NAIPC)			DANG, TRUNG Q			
P.O. BOX 506 MERRIFIELD			ART UNIT PAPER NUMBER			
	,		2823			
				DATE MAILED: 07/26/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

	·	Application No.	Applicant(s)				
Office Action Summary		10/709,664	MIN-HSUN HSIEH	(lux			
		Examiner	Art Unit				
		Trung Dang	2823				
 Period for	The MAILING DATE of this communication ap Reply	pears on the cover sheet with the o	correspondence address -	•			
THE MA - Extension after SI - If the pe - If NO pe - Failure Any rep	RTENED STATUTORY PERIOD FOR REPLAILING DATE OF THIS COMMUNICATION. ons of time may be available under the provisions of 37 CFR 1. K (6) MONTHS from the mailing date of this communication. eriod for reply specified above is less than thirty (30) days, a reriod for reply is specified above, the maximum statutory period to reply within the set or extended period for reply will, by statut by received by the Office later than three months after the mailing patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, however, may a reply be timely within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE	mely filed vs will be considered timely. the mailing date of this communication (35 U.S.C. § 133).	ation.			
Status							
1)⊠ R	esponsive to communication(s) filed on 07 J	lune 2005.					
·		s action is non-final.					
·	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Dispositio	n of Claims						
5)☐ C 6)⊠ C 3 7)☐ C	laim(s) 1-7 and 9-13 is/are pending in the aparts) Of the above claim(s) is/are withdrawallaim(s) is/are allowed. laim(s) 1-7 and 9-13 is/are rejected. laim(s) is/are objected to. laim(s) are subject to restriction and/o	awn from consideration.					
Application	n Papers						
10)⊠ TI A R	ne specification is objected to by the Examinate drawing(s) filed on 21 May 2004 is/are: a pplicant may not request that any objection to the eplacement drawing sheet(s) including the correction of the control of the)⊠ accepted or b)⊡ objected to e drawing(s) be held in abeyance. Se ction is required if the drawing(s) is ob	e 37 CFR 1.85(a). ejected to. See 37 CFR 1.12				
Priority un	der 35 U.S.C. § 119						
12)	cknowledgment is made of a claim for foreign All b) Some * c) None of: Certified copies of the priority document Certified copies of the priority document Copies of the certified copies of the priority document application from the International Bureate the attached detailed Office action for a list	ats have been received. ats have been received in Applicat brity documents have been received in Priceived.	ion No ed in this National Stage				
Attachment(s)						
2) Notice (3) Informa	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) tion Disclosure Statement(s) (PTO-1449 or PTO/SB/08 lo(s)/Mail Date 12/22/04.	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal I 6) Other:					

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DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-7 and 9-13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lebby taken with Yang in view of Yamazaki et al., all of record.

Lebby et al. teach a method for forming a LED comprising the steps of: forming a first stack composed of LED epitaxial layers, wherein the forming comprises following steps:

forming a first stack, wherein the step of forming a first stack comprises the steps of:

providing a first GaAs substrate 12;

forming a second contact layer 14 of GaAs on the first substrate;

forming a second cladding layer 15 on the second contact layer;

forming an emitting layer 16 on the second cladding layer;

forming a first cladding layer 17 on the emitting layer;

forming a first contact layer 18 of GaAs on the first cladding layer;

forming a transparent conductive layer 20 of indium tin oxide (ITO) on the first contact layer;

forming a second stack comprising forming a transparent adhesive layer 22 of **epoxy** on a second transparent substrate 25; and

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holding together said first stack and said second stack by means of the transparent adhesive layer 22 (Figs. 1-2 and related text).

Note that the epoxy is an organic material therefore the epoxy transparent adhesive layer 22 reads on the claimed organic transparent adhesive layer.

Lebby et al. differs from the claims in not disclosing the steps of forming a second reaction layer over the first stack, forming a first reaction layer over the second stack, and holding together said first reaction layer and said second reaction layer by means of a transparent adhesive layer as recited in the amended claim 1.

Yang et al. teach that in order to improve the adhesion property between a LED epitaxial structure and a transparent substrate, a layer of adhesion promoter can be formed on the surface of the LED epitaxial structure and on the surface of the transparent substrate before a transparent adhesive layer is formed thereon (col. 4, lines 1-6).

It would have been obvious to one of ordinary skill in the art to modify Lebby's process by forming an adhesion promoter layer on the surface of the LED first stack (i.e., on the ITO layer 20) and on the surface of the transparent substrate 25 (i.e., between substrate 25 and adhesive layer 22) because the presence of the adhesive promoter layer would enhance the adhesion between the LED first stack and the transparent substrate as suggested by Yang. Note that, the adhesion promoter layers formed on the LED first stack reads on the claimed second reaction layer and the adhesion promoter layer formed on the surface of the transparent substrate 25 reads on the claimed first reaction layer. Accordingly, the two adhesion promoter layers are hold together by means of the transparent adhesive layer 22.

The combined process of Lebby and Yang is now different from the claims in not disclosing the material of the adhesion promoter layer as claimed. Yamazaki et al. teach that metal material including titanium (Ti) and chromium (Cr) is used to enhance the adhesive properties between a transparent substrate and an ITO

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transparent conductive layer (paragraph [0068]). It would have been obvious to one of ordinary skill in the art to use Ti or Cr for the adhesion promoter layer of the combined process of Lebby and Yang because this would enhance the adhesion between the transparent substrate 25 and the ITO transparent conductive layer 20 of the LED structure depicted in Lebby's Fig. 6.

For claim 3, see Fig. 3 and col. 4, lines 54-55 for the removal of the first substrate 12. Also, see Fig. 4 for the etching of the second contact layer 14, the second cladding layer 15, the emitting layer 16, the first cladding layer 17, and the first contact layer 18. See Fig. 6 for the forming of a first electrode 30 on the second contact layer 14, and a second electrode 32 on the transparent conductive layer 20.

For claims 5 and 6, although Lebby et al. disclose an AlGaAs LED, Yang et al. in column 3, lines 1-12 teach an AlGaInP LED that uses compound semiconductor materials for the contact layer, the first and second cladding layers, and the emitting layer as recited in the pending claims 5 and 6. Thus, it would have been obvious to one of ordinary skill in the art to use the compound semiconductor materials of the pending claims 5 and 6 for the aforementioned layers as taught by Yang because it is known to use such materials in the fabrication of a LED device having a wave length of 635nm (Yang, col. 4, lines 33-34), and the employment of a known material to make the same would have been within the level of one skilled in the art.

As for claim 9, see Yang col. 2, lines 26-27 and col. 3, lines 49-51 for the teaching of transparent adhesive material of BCB is equivalent to the epoxy transparent adhesive material.

As for claims 12 and 13, since the materials for the first reaction layer, the second reaction layer, and the transparent adhesive layer taught in the combined teaching are identical with that of disclosed in the present invention, the mechanism by which the layers are bonded together must inherently be the same, absent evidence to the contrary.

Response to Arguments

3. Applicant's arguments filed 06/07/05 have been fully considered but they are not persuasive.

In the Remarks, applicants argue that Yamazaki teaches the use of Ti and Cr in the reaction layer for promoting adhesion, and none of the cited prior art teach using an organic transparent adhesive layer to hold together a first reaction layer and s second reaction layer. The Examiner disagrees. As noted in the rejection, Lebby, not Yamazaki, is relied upon to show an epoxy (i.e., organic) transparent adhesive layer 22. Yang and Yamazaki are relied to show the teaching of using Ti or Cr as an adhesion promoter layer. In the combination, the adhesion promoter layer formed on the LED first stack reads on the claimed second reaction layer and the adhesion promoter layer formed on the surface of the transparent substrate 25 reads on the claimed first reaction layer. Accordingly, the first reaction layer and the second reaction layer are hold together by means of the organic transparent adhesive layer 22 as claimed.

Conclusion

4. This is a RCE of applicant's earlier Application No. 10/709,664. All claims are drawn to the same invention claimed in the earlier application and could have been finally rejected on the grounds and art of record in the next Office action if they had been entered in the earlier application. Accordingly, **THIS ACTION IS MADE FINAL**

even though it is a first action in this case. See MPEP § 706.07(b). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no, however, event will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Trung Dang whose telephone number is 571-272-1857. The examiner can normally be reached on Mon-Friday 9:30am-6:00pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on 571-272-1855. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status

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information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Trung Dang Primary Examiner Art Unit 2823

07/25/05

Mung Day